T/VIII/M-7 7 April 1965

UNITED STATES INTELLIGENCE BOARD

COMMITTEE ON DOCUMENTATION

TASK TEAM VIII - PHOTO CHIP

Minutes of the Seventh Session, 8 - 12 March 1965

LICINOCEG	or meir kepresentatives Present
DIA	
CIA	
ARMY AIR FORC NAVY CSS	- Lt. Col. James Mylar Mr. Ben Adams E - Capt. William Turner, FTD Maj. Thomas Mongno, TAC - Mr. Thomas Seymour
touring and rela CIA/OCR with emp	Briefing/Inspection. The first four days of the session were ceiving briefings on selected aspects of the chip problem and in certain government facilities to inspect chip systems in operation ted equipments, procedures and problems. Chief, 25X1A Graphics Register, briefed on the Register's mission and operations, hasis on the existing photo chip file, its application and the ations that led to the selection of the Graphics Register 70mm chip
chips to and whit nature o	Prospective developments in chip files were also discussed. CIA/ORR/Geographic Area, presented the plan to apply the problem of storing and reproducing charts and maps, both black e, and colored. Particular attention was placed on the specialized f the requirements for the chip system and the limitations of technologies and monies. 25X1A
the advan	Main topics covered were highly miniaturized diode arrays in relation to high density data block design and techniques, and video and voice correlations and 25X1A nced design and processing techniques embodied in a chip printer ntract, but on which limited information is presently releasable
NAVY and	Group 1 I DIA review(s) S-E-C-R-E-T Approved for Release 2005/04/28: CIA-PDR80B01139A046540289408554+1

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represented the gave a most enlightening presentation the operating capabilities and deficiencies of existing systems, and the use of weighted system characteristics in developing formulas for application to the design of a given functional chip system.

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briefed the team on the capabilities of existing and short-term upcoming film and card handling equipments as they related to the photo chip problem.

3. At the Army Map Service, the team received a briefing in the general area on AMS responsibilities and operations in the field of maps, charts, and related materials, with emphasis (a) on present and expected chip applications and (b) on international arrangements. A later briefing on GIMRADA outlined the research and development programs in the mapping and charting fields, especially those bearing on chip size, the use of chips in storage and retrieval and the use of chips in reproduction, both dry and wet, to meet tactical operating needs while reducing logistics burdens and time delays. The team also was briefed at Suitland, Maryland, on the activities of the Naval Oceanographic Office related to the chip inquiry, with particular reference to the emerging R&D needs of Nav Ocean in the chip field, and to the considerations bearing on chip design and size determinations in the early development stages. Also at Suitland, the team received a briefing on the Navy's general utilization program for sensitive aerial photography, and on the several chip applications made to date to meet the priority day-to-day operating needs of the US fleet. team then toured the Navy's operating chip facilities and inspected both the equipments being used to provide chip systems to operating fleet-components and some R&D equipments being evaluated in relation to future operational requirements in the aerial photo chip field. Of special interest were (a) (RADIC) Navy Storage-Retrieval Display System for Intelligence chips, (b) an R&D system embodying console controlled chip retrieval and electronic display capable of image intensification and zoom magnification; and, (c) the sussion technique of making "chip substitutes" available.

The Working Session. The team noted the minutes of the 5-6-7 January session and the 8-12 February session. The team then turned its attention to reviewing the new version of the Terms of Reference which the Chairman explained had been altered by him, and the Secretary to meet the deadline set for a CODIB meeting on 4 March, but which was later deferred to March 18. raised the point of sharpening the statement of the objective to emphasize the obligation of the team to seek a solution to the standardization problem in the aerial reconnaissance chip field. It was agreed to insert the idea of the feasibility of photo chip standardization ahead of "...recommend to CODIB..., and to add the specific USIB charge to CODIB as a footnote to the objective statement. The Secretary was then instructed to request the CODIB Secretary to disseminate, if time permits, the changed terms to the CODIB members for perusal prior to the next CODIB meeting.

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25X1A	5. The Chairman then advised the team that he and the Secretary and acting as an Executive Working Party, inter alia, had prepared a summary status report for the use of the Chairman, CODIB, in briefing the President's Advisory Board on Foreign Intelligence on accomplishments to date by the Community in remedying the deficiencies in information processing cited in the original SCIPS report. The Secretary provided the team members with a summary of the responsibilities of the President's Foreign Intelligence Advisory Board and a description of the essential recommendations of the SCIPS report. The team requested, and the Chairman agreed, that the Interim States Board and a greed, that the Interim States Board and a description of the SCIPS report.
25X1A	reported that the team request for an assessment of film degra- dation had been forwarded to the appropriate component, and that he would check on the status of the team request for a check of the status of the team request for a check of the status of the team request for a check of the status of the team request for a check of the status of the team request for a check of the status of the team request for a check of the status of the team request for a check of the status of the team request for a check of the status of the team request for a check of the status of the team request for a check of the status of the team request for a check of the status of the team request for a check of the status of the team request for a check of the status of
25X1A	certain physical objects as they relate to photo chip physical characteristics. felt that a draft version of the latter or an oral summary should be available for the next team meeting.
	6. Mr. Thomas Seymour proposed that a graphic compilation be made of all chips obtained or inspected to date as an essential preliminary to the next meeting. The Chairman agreed, and Mr. Seymour was selected by acclamation to undertake this project, with authority to call upon any team member for support. (Address - Navy Reconnaissance Technical Support Center, 4301 Suitland Road, Suitland, Maryland) In the discussion that ensued, it was generally agreed that the next meeting of the team should concentrate upon the compilation, summary and analysis of all documentation acquired to date, and that in general the next session should be regarded as the basic preparation of materials to be used in the initial drafting of the team report. It was also agreed that all team members should bring to the next meeting additional samples of operating chip systems and appropriate documentation. The question was raised as to the relationship between the Chip Team inquiry and the DoD R&E program of research in the field of chip creation and chip processing. The Chairman agreed to look into this matter, including the current DIA R&D efforts, and to report at the next session.
25X1A	7. For forward planning, it was agreed that there should be two 2-3 day sessions at two week intervals, and that these should be followed by a full-week session dedicated to the completion of the rought draft of the team report to CODIB. agreed to undertake to arrange appropriate facilities for the full-week session. The Secretary agreed to notify all hands of the time and place of the next three sessions as soon as
í	arrangements were completed.
	Attachment
	Attachment: Copy of Interim Task Team Status Report

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Status Report on CODIB Task Team VIII (Photo Chips)

1. General Goal:

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The Task Team has set out to examine evidence essential to formulating recommendations to CODIB for the most effective and efficient means of utilizating photo chips, as required, in the processing of photographic information (primarily aerial) for all organizations within the purview of USIB. This called for an assessment of the current and prospective value of photo chips, considering requirements, benefits, and disadvantages of standardization of chips in terms of physical size, internal format design, resolution characteristics, etc.

2. The Plan:

- A. Task Team Composition: The Chairman (having served on a special committee of the Inter-Service Coordinating and Integrating Group (ISCIG) that had made recommendations for a standard photo chip to serve the tactical needs of the Department of Defense) selected the most knowledgeable representatives to be found in the services, the Unified and Specified Commands, and CODIB to attack the problem in the most direct and effective manner. The selected Task Team members have the proper clearances, "need to know", and the operational experience to examine all aspects of the problem within the Intelligence Community from both a strategic and tactical viewpoint. Because of the operational applications of any Team findings, the Team has been meeting in regular 3 to 5 day sessions since October 1964.
- B. Approach and Action to Date: The Team is examining pertinent reports and as many of the operational and planned photo chip systems as practical, and has obtained briefing on selected aspects of photo chips and related systems from the most knowledgeable people available. Particular attention is being devoted to prospective technological developments pertaining to chip handling equipment, chip content design, film emulsion chemistry, the physics of film bonds and bases, acquisition film sizes and resolution, and the electronics, optics and mechanics involved in chip creation, handling and interpretation.

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